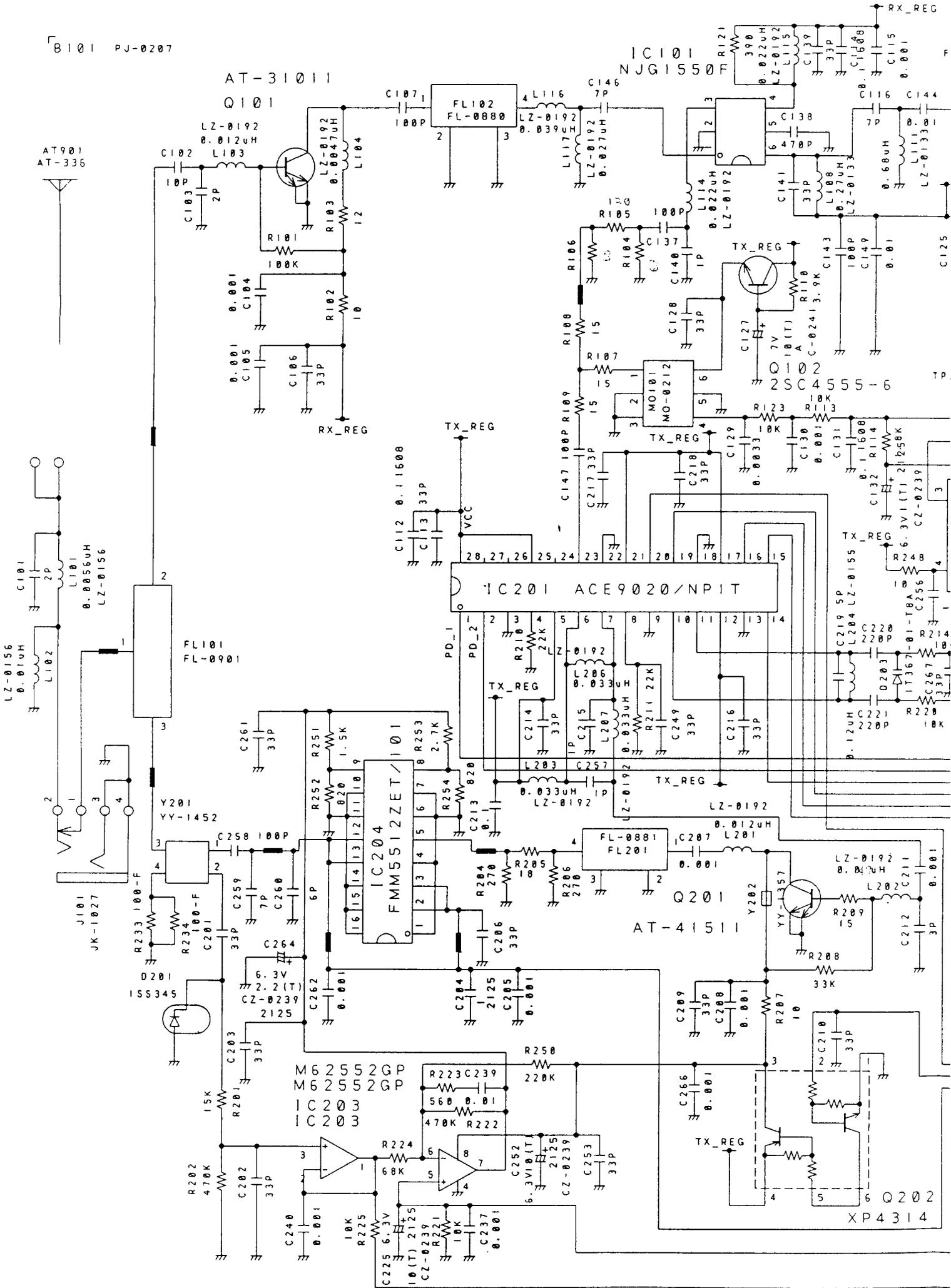
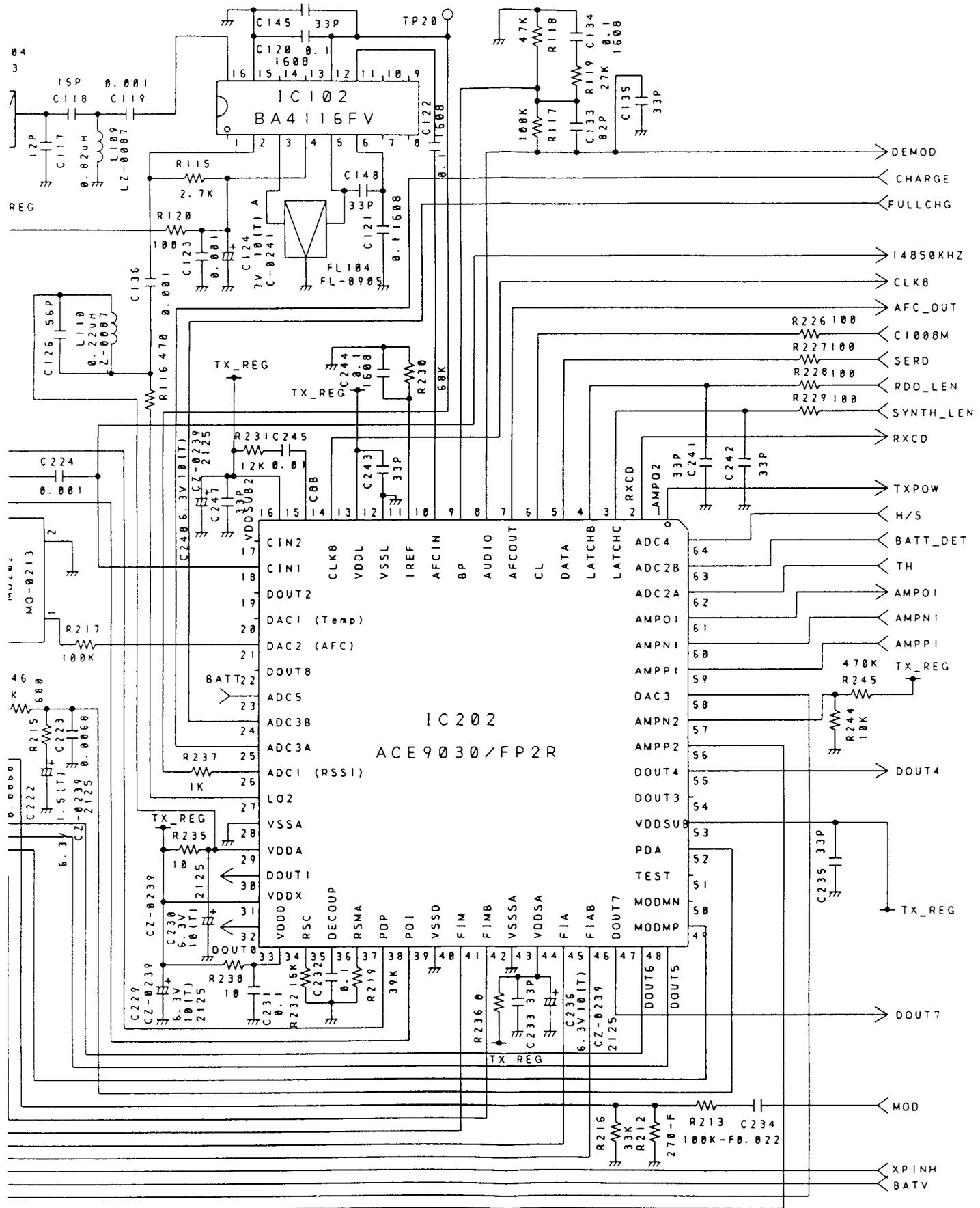


RF SCHEMATIC
(Left Panel)



RF SCHEMATIC
(Right Panel)



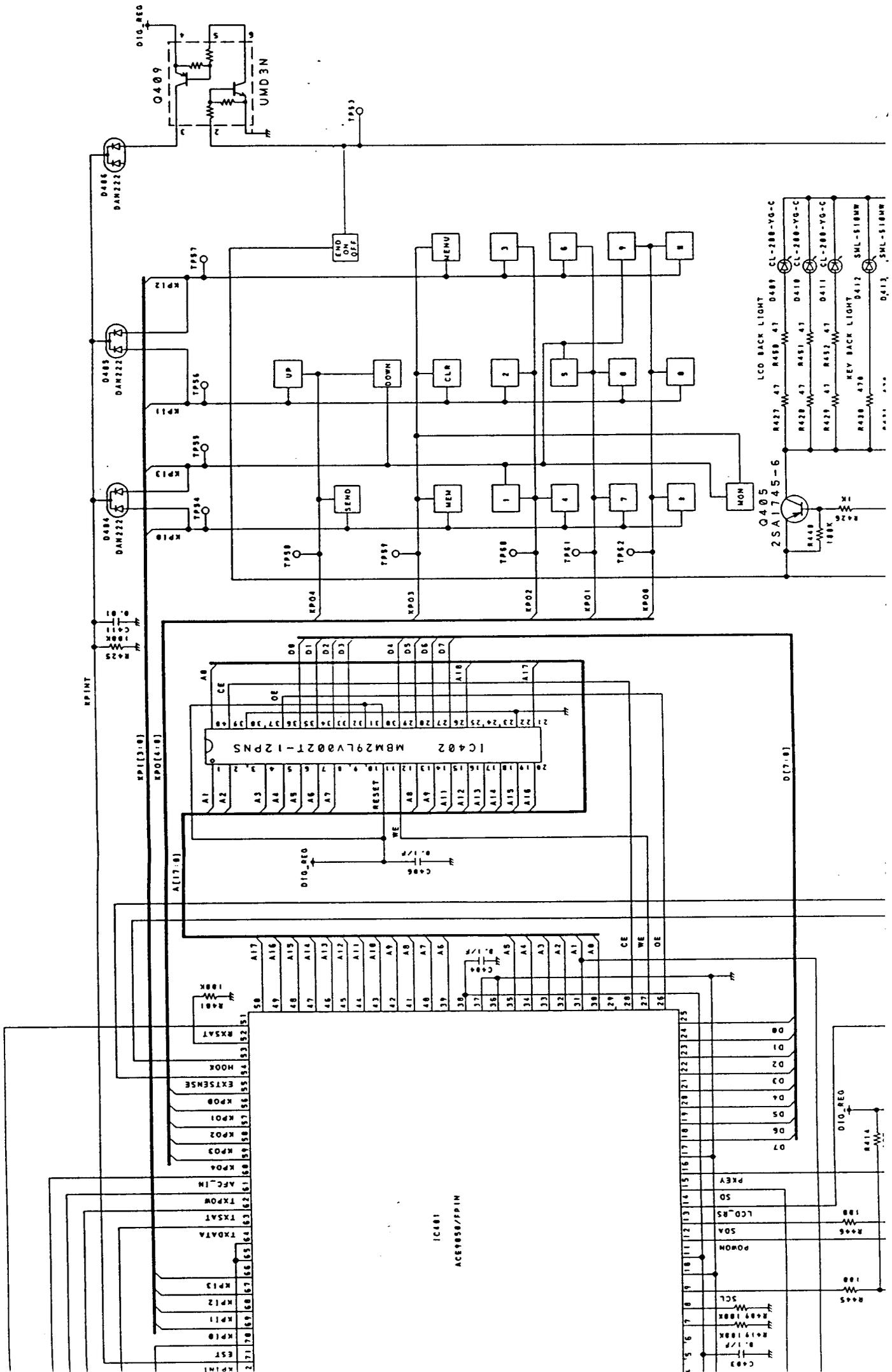
- NOTES
1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. (K=KILO OHM, M=MEG OHM)
 2. RESISTOR WATTAGES ARE [1/16W] UNLESS OTHERWISE NOTED.
 3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P=MICRO-MICRO FARAD)
 4. ALL CAPACITORS TEMPERATURE CHARACTERISTICS ARE [CH] (LESS THAN 820PF) OR [B] (MORE THAN 1000PF) UNLESS OTHERWISE NOTED.

DESIGN	DRAWN BY	UNIDEN No.	MODEL No.
97/12/12	98/3/30	UH-045ZP	
KKOZO	KKOZO	TITLE	RF
CHECK BY	APPRO BY	SCHEMATIC DIAGRAM	
		DRAWING No.	
REV. No		UNIDEN CORP.	

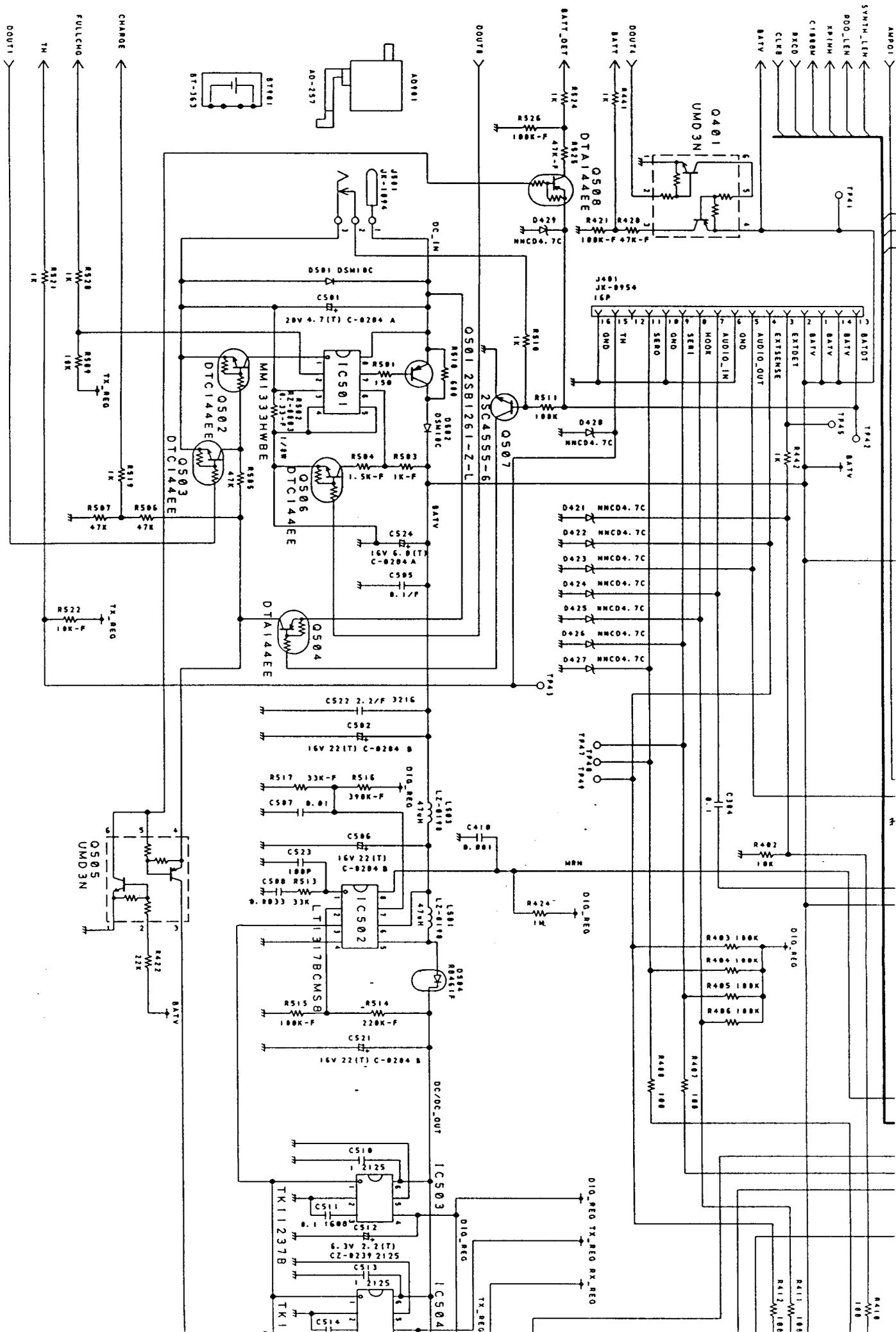
FILE: EXH-D-04

FCC ID: AMWUH045

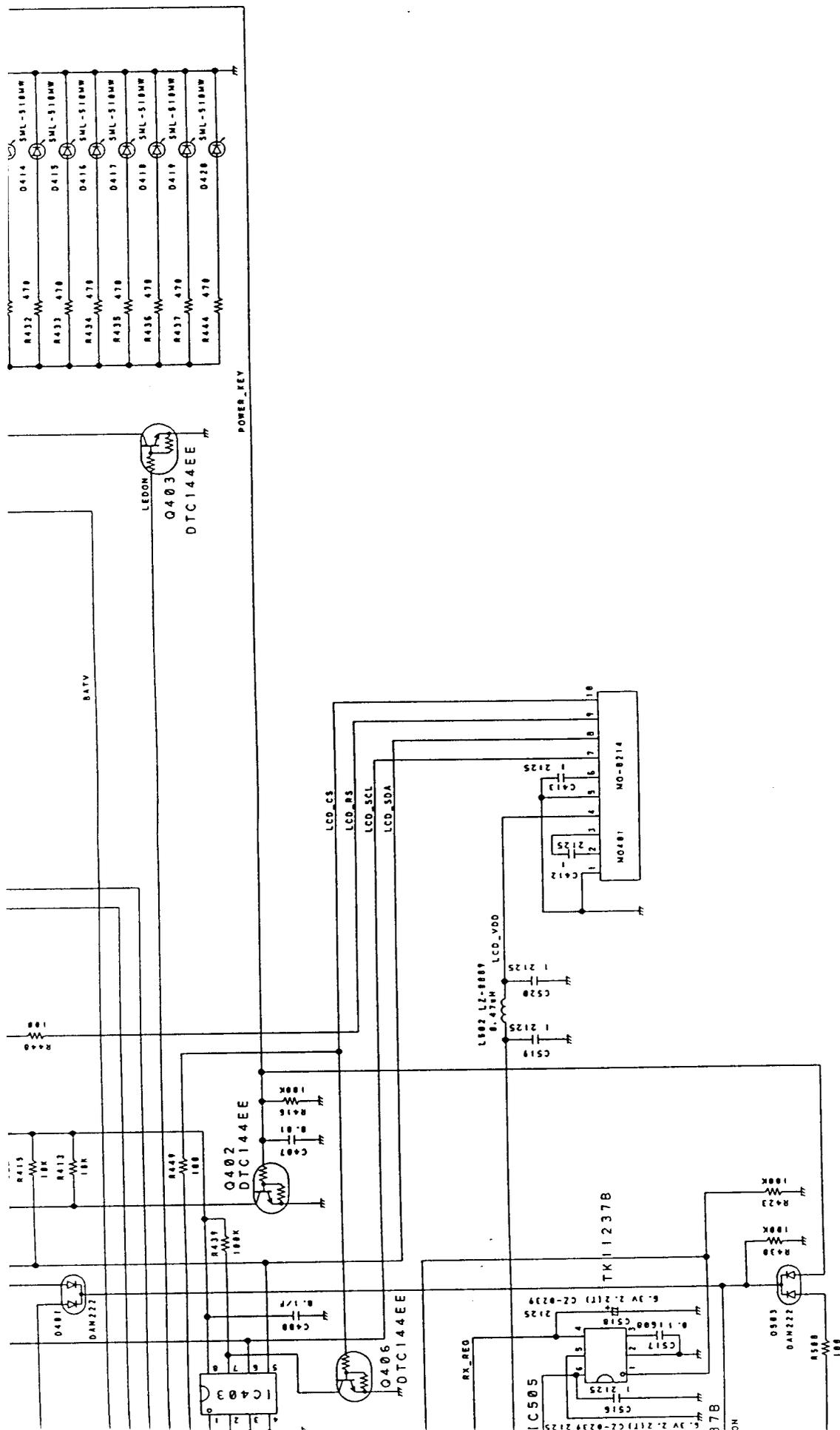
MAIN SCHEMATIC
(Top Right Panel)



MAIN SCHEMATIC
(Lower Left Panel)



MAIN SCHEMATIC
(Lower Right Panel)



- NOTES:
1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. (K=KILO OHM, M=MED OHM)
 2. RESISTOR WATTAGES ARE [1/16W] UNLESS OTHERWISE NOTED.
 3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P=MICRO-MICRO FARAD)
 4. ALL CAPACITORS TEMPERATURE CHARACTERISTICS ARE [CH] (LESS THAN 500PF) UNLESS OTHERWISE NOTED. OR [B] (MORE THAN 1000PF) UNLESS OTHERWISE NOTED.
 5. CHIP PARTS ARE NOT SPECIFIED IN THIS DRAWING PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.
 6. CHIP CAPACITORS TYPE ARE [1065] UNLESS OTHERWISE NOTED.

DESIGN	DRAWN BY	UNIDEN NO.	MODEL NO.
SHIMIZUM	EKOZO	UM-045ZP	
98/03/30	98/3/15	TITLE LOGIC	
CHECK BY	APPROV BY	SCHEMATIC DIAGRAM	
		DRAWING NO.	
REV. NO.			UNIDEN CORP.